

ISSUED DAT VERSION	E: <u>2015-10-</u> : Ver 1.0	13
■Prelin	ninary Specifica	ation
	Product Specification	
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Approved by		Notes
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Approved by	Checked by	Approved by
IA Confirmed :		

MODEL NO. : TM022HDHT11-00



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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2015-10-13	Preliminary Specification Release	Ke Ke
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1. General Specifications

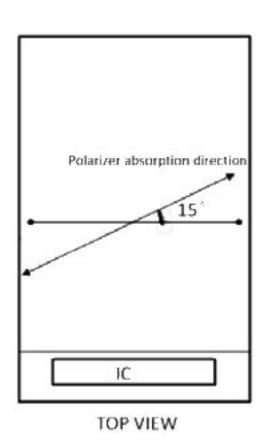
	Feature	Spec		
	Size	2.2inch		
	Resolution	240 (RGB) x320		
	Technology Type	a-si		
	Pixel Configuration	R.G.B Vertical Stripe		
Display Spec.	Pixel pitch(mm)	0.141x0.141		
Display Spec.	Display Mode	ECB Mode, Transflective		
	Surface Treatment	Clear(3H)		
	Viewing Direction	6 O'Clock		
	Gray Scale Inversion Direction	12 O'Clock(IC 6 O'Clock)		
	Top Polarizer absorption angle	15°		
	LCM (W x H x D) (mm)	40.6x56.6x2.7		
Mechanical	Active Area(mm)	33.84mm x 45.12mm		
Characteristics	With /Without TSP	Without TSP		
Ondi dotoriotios	LED Numbers	4LEDs serial		
	Weight (g)	TBD		
Electrical	Interface	RGB 18 bits+3SPI		
Electrical Characteristics	Color Depth	262K		
	Driver IC	ILI9341		

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: ± 5%

Note 4: Top Polarizer absorption angle pattern:





2.Input/Output Terminals

No	Symbol	I/O	Description	Comment
1	VL1(LED+)	I	Power supply for LED(High voltage)	
2	VL2(LED-)	I	Power supply for LED(Low voltage)	
3	GND	Р	Ground	
4	VDD	Р	Power supply of gate driver(high level)	
5	GND	Р	Ground	
6	VSYNC	I	Vertical sync. signal	
7	RESET	I	Reset Enable	
8	GND	Р	Ground	
9	CS	I	SPI Chip select	
10	SDO	0	SPI serial Data output	
11	SDI	ı	SPI serial Data input	
12	GND	Р	Ground	
13	SCL	ı	SPI serial interface clock	\rightarrow
14	GND	Р	Ground	>
15	B5	ı	Blue data signal	
16	B4	I	Blue data signal	
17	B3	I	Blue data signal	
18	B2	ı	Blue data signal	
19	B1	T I	Blue data signal	
20	B0	ı	Blue data signal	
21	ENABLE	ı	Data Enable signal	
22	HSYNC	ı	Horizontal sync signal	
23	GND	Р	Ground	
24	DCLK	T I	Data sampling clock signal	
25	GND	Р	Ground	
26	G5	l l	Green data signal	
27	G4	l l	Green data signal	
28	G3	I	Green data signal	
29	G2		Green data signal	
30	G1	(1/2)	Green data signal	
31	G0		Green data signal	
32	GND	Р	Ground	
33	R5	SIL	Red data signal	
34	R4	I	Red data signal	
35	R3	, I	Red data signal	
36	R2		Red data signal	
37	R1		Red data signal	
38	R0		Red data signal	
39	GND	Р	Ground	

Note1: I—Input, O—Output, P—Power/Ground



3. Absolute Maximum Ratings

ltem	Symbol	MIN	TYP	MAX	Unit	Remark
Supply Voltage	VCI	-0.3	-	4.6	V	
Supply Voltage	VDDI(logic)	-0.3	-	4.6	V	
Logic Input Voltage Range	VIN	-0.3	-	VDDI+0.3	V	
Back Light Forward Current	I _{LED}		-	25	mA	
Operating Temperature	T _{OPR}	-20	-	70	°C	
Storage Temperature	T _{STG}	-30	-	80	°C	

4. Electrical Characteristics

4.1 LCD Module

VSS=GND,Ta=25°C

					1,42 2,12,111 20 0				
lt€	em	Symbol	MIN	TYP	MAX	Unit	Remark		
Supply Voltag	ge for analoge	VDD	2.5	2.8	3.3	V			
Supply Volta	ge for digital	VDDI	1.65	2.8	3.3	\supset			
Logic Input	Low Level	V_{IL}	VSS		0.3* VDDI	٧			
Voltage	High Level	V_{IH}	0.7* VDDI		VDDI	٧			
Logic Output	Low Level	V _{OL}	VSS		0.2VDDI	V			
Voltage	High Level	V _{OH}	0.8VDDI		VDDI	V			

Table 4.1 LCD module electrical characteristics

4.2 Backlight Unit

Ta=25°C

ltem	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F	-	20	-	mA	41 EDa
Forward Current Voltage	V _F	-	12.8	-	V(4 LEDs)	4LEDs Serial
Backlight Power Consumption	W_{BL}	-	256	-	mW	Serial
Operating Life Time	_	10000	20000		Hrs	

Table 4.2 Backlight Unit Electrical Characteristics

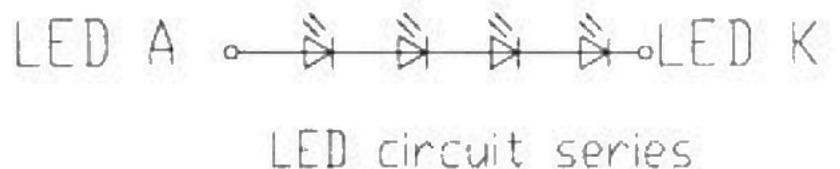
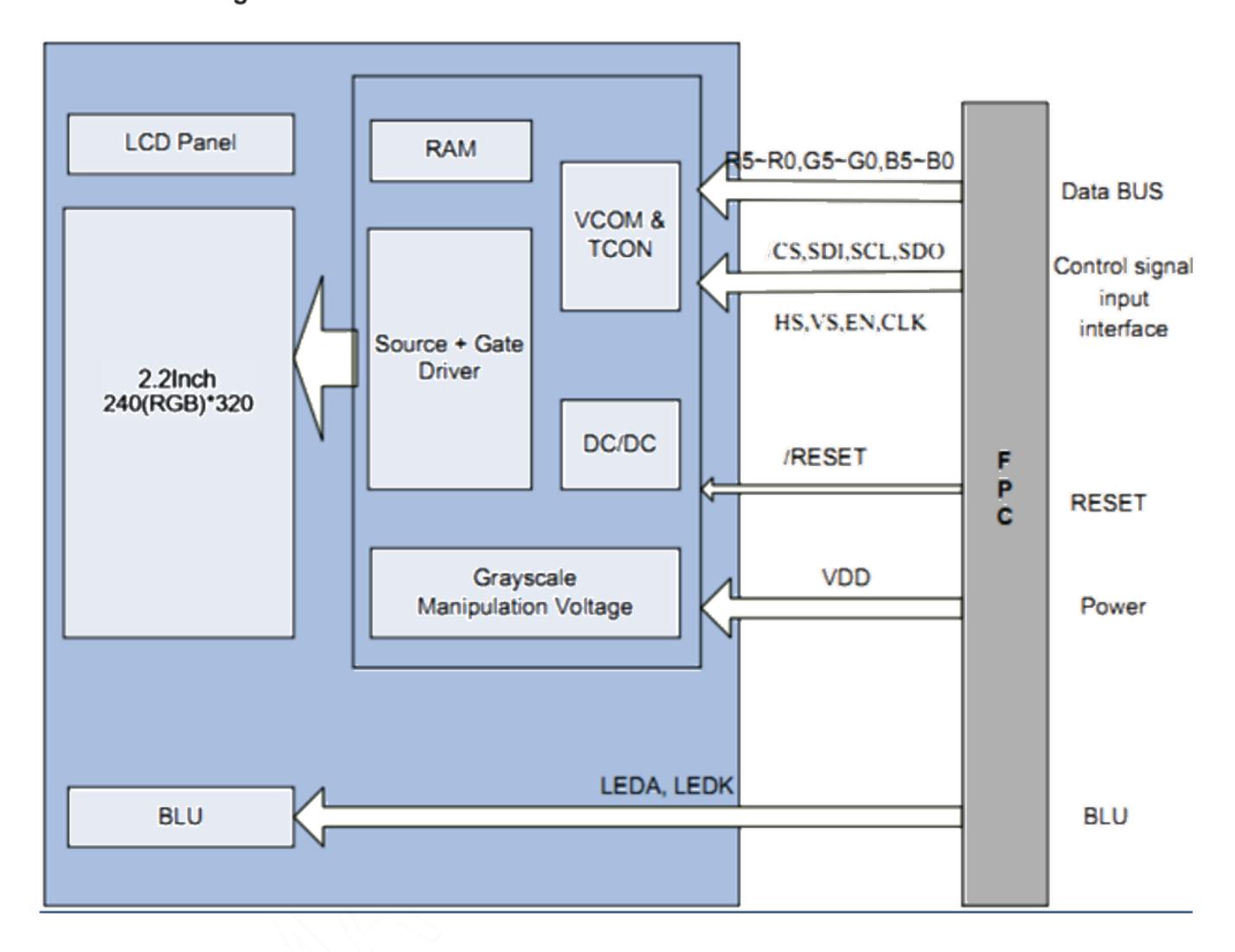


Figure 4.2.1 LED Driver Circuit



4.3 BLOCK DIAGRAM

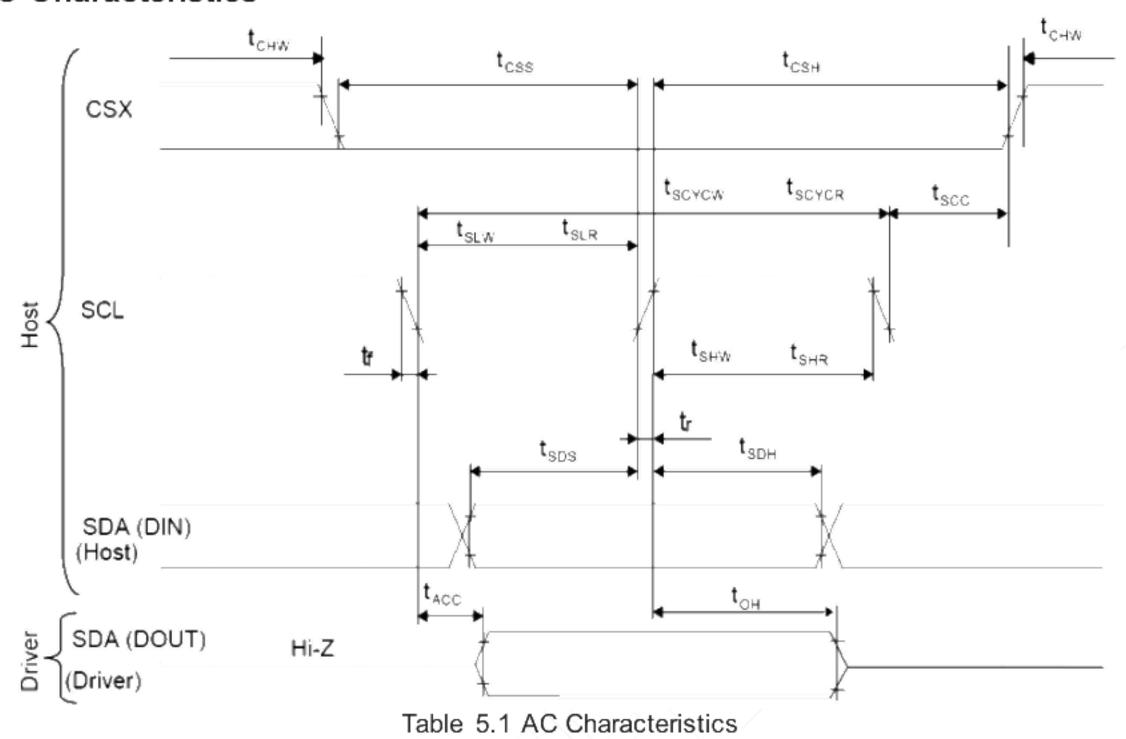
LCD module diagram





5. Timing Chart

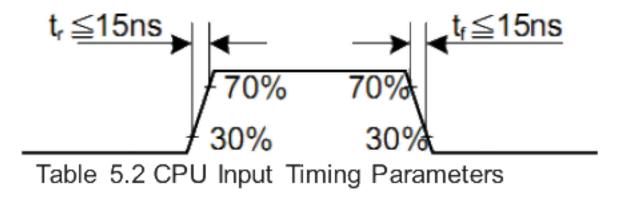
5.1 AC Characteristics



5.2 3 Wire-SPI Interface Input Timing parameters

Signal	Symbol	Parameter	min	max	Unit	Description
	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
SCL	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
SCL	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
tslr		SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI	tsds	Data setup time (Write)	30	-	ns	
(Input)	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO	tacc	Access time (Read)	10	-	ns	
(Output) toh		Output disable time (Read)	10	50	ns	
_	tscc	SCL-CSX	20	-	ns	
CSX	tchw	CSX "H" Pulse Width	40	-	ns	
CSX	tcss	CSX-SCL Time	60	-	ns	
	tcsh	CSA-SCL TIME	65	-	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V





5.3 Parallel 18/16/6-bit RGB Interface Timing Characteristics

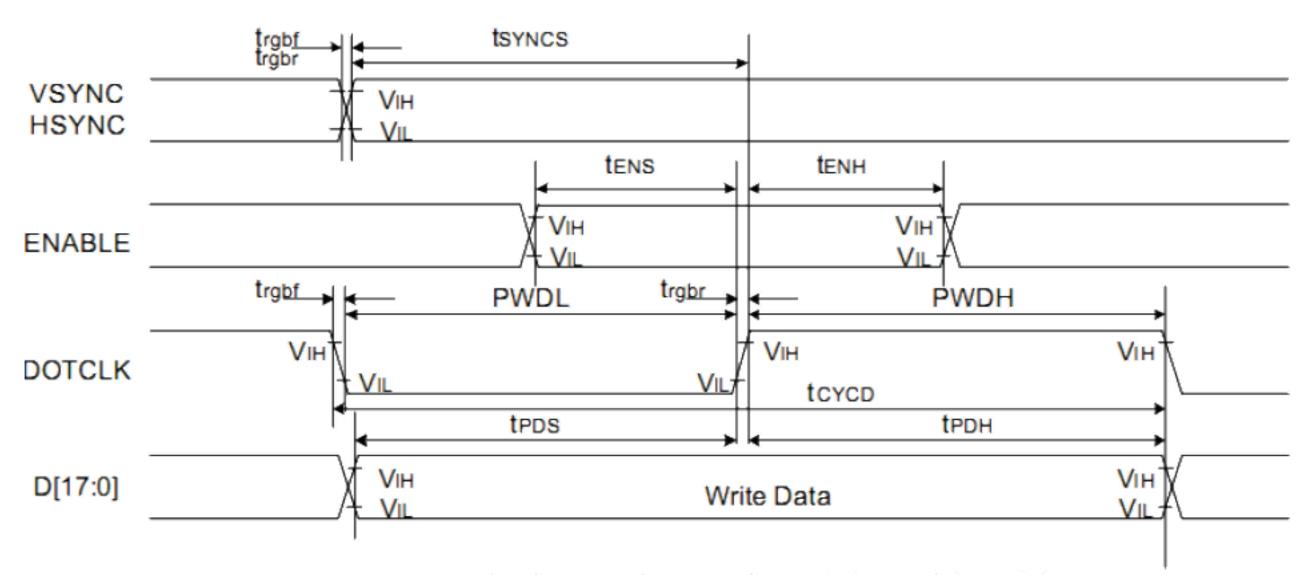
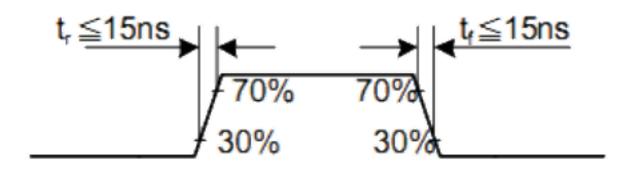


Figure 5.3 Parallel 18/16/6-bit RGB Interface Timing Characteristics

5.4 Parallel 18/16/6-bit RGB Interface Timing parematers

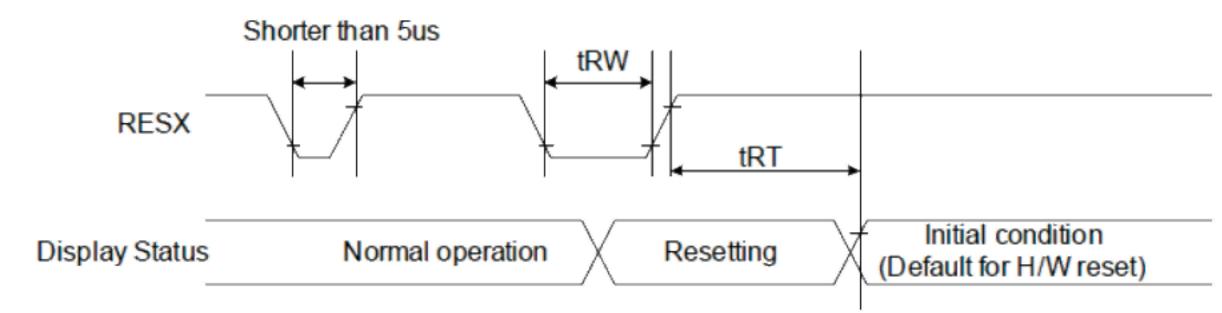
Signal	Symbol	Parameter		max	Unit	Description
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	-	ns	
DE	tens	DE setup time	15		ns	
DĒ	t _{ENH}	DE hold time	15	-	ns	
D(17:01	teos	Data setup time	15		ns	18/16-bit bus RGB
D[17:0]	teda	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level period	15	-	ns	
DOTCLK	PWDL	DOTCLK low-level period	15	•	ns	
DOTOLK	tcyco	DOTCLK cycle time	100	-	ns	
	trgbr , trgbr	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	-	ns	
DE	tens	DE setup time	15	-	ns	
DE	tenn	DE hold time	15	-	ns	
D(17:01	teos	Data setup time	15		пŝ	6-bit bus RGB
D[17:0]	t _{PDH}	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level pulse period	15	-	ns]
DOTCLK	PWDL	DOTCLK low-level pulse period	15	-	ns	
DOTOLK	toyon	DOTCLK cycle time	100	-	ns	
	trgbr , trgbf	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V





5.5 Reset timing



Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
		Poset cancel		5 (note 1,5)	mS
	tRT	Reset cancel		120 (note 1,6,7)	mS

Figure 5.4.1 Reset Timing Diagram



6. Power on/off sequence

Power Off Sequence-Power ON Sequence Power Supply ON (VCI.IOVCC) Normal Display GND., Enter Sleep Sequence i Rising time 100us or more VCI and IOVCC could powered 120ms or ... Up in any orders more -Power Supply OFF (VCI,IOVCC) 1ms or more Hardware Reset SND Power setting-VCI and IOVCC could powered. 120ms or more Display Setting down in any proens a R11h 60ms or more Display On a Sequence : R29h-Display ON Figure 6.1 Power on/off setting up flow



6 Optical Characteristics

6.1 Driving the backlight condition (Transmissive mode)

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		38	48			
View Angles		θВ	CD > 10	35	45		Dograd	Note 2.2
View Aligies		θL	CR≧10	30	40		Degree	Note2,3
		θR		40	45			
Contrast Ratio)	CR	θ=0°	100	120			Note 3
Response Tim	Posponso Timo		25℃		35	50	ms	Note 4
response rin		T _{OFF}	25 (33		1113	14016 4
Chromaticity	White	х	θ=0°	-	0.273	-/		Note 1,5
Cilioniaticity	VVIIILE	у	0-0	-	0.296			
Luminance		L		80	90	/ \>	cd/m ²	
Uniformity				70%	80%			Note 7
NTSC				45%	50%	l		

6.2 Not Driving the backlight condition(Reflective mode)

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark
	θТ	CR≧2	60	70		Degree	Note1,2,3
View Angles	θВ		60	70			
View Aligies	θL		60	70			
	θR		60	70			
Contrast Ratio	CR	θ=0°	7	10			Note 3
Response Time	Ton	25℃	25	40	ma	Note 4	
Response Time	T _{OFF}			25	40	ms	Note 4
Reflection ratio			4.8%	5.5%			
NTSC			5.5%	7%			Note 1

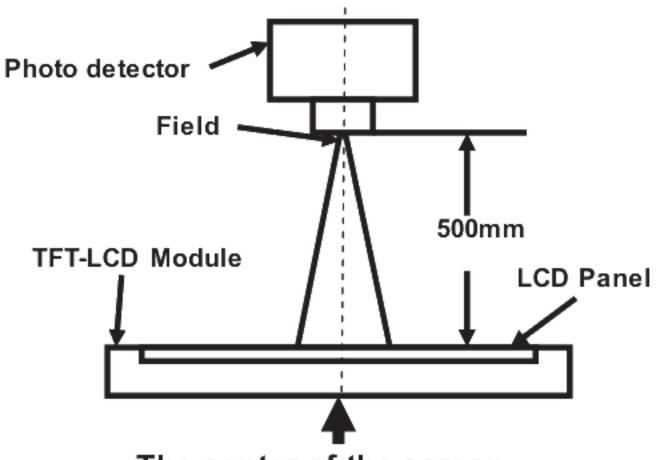
Test Conditions:

- I_F= 20 mA, and the ambient temperature is 25℃.
- 2. The test systems refer to Note 1 and Note 2.



Note 1: Definition of optical measurement system.

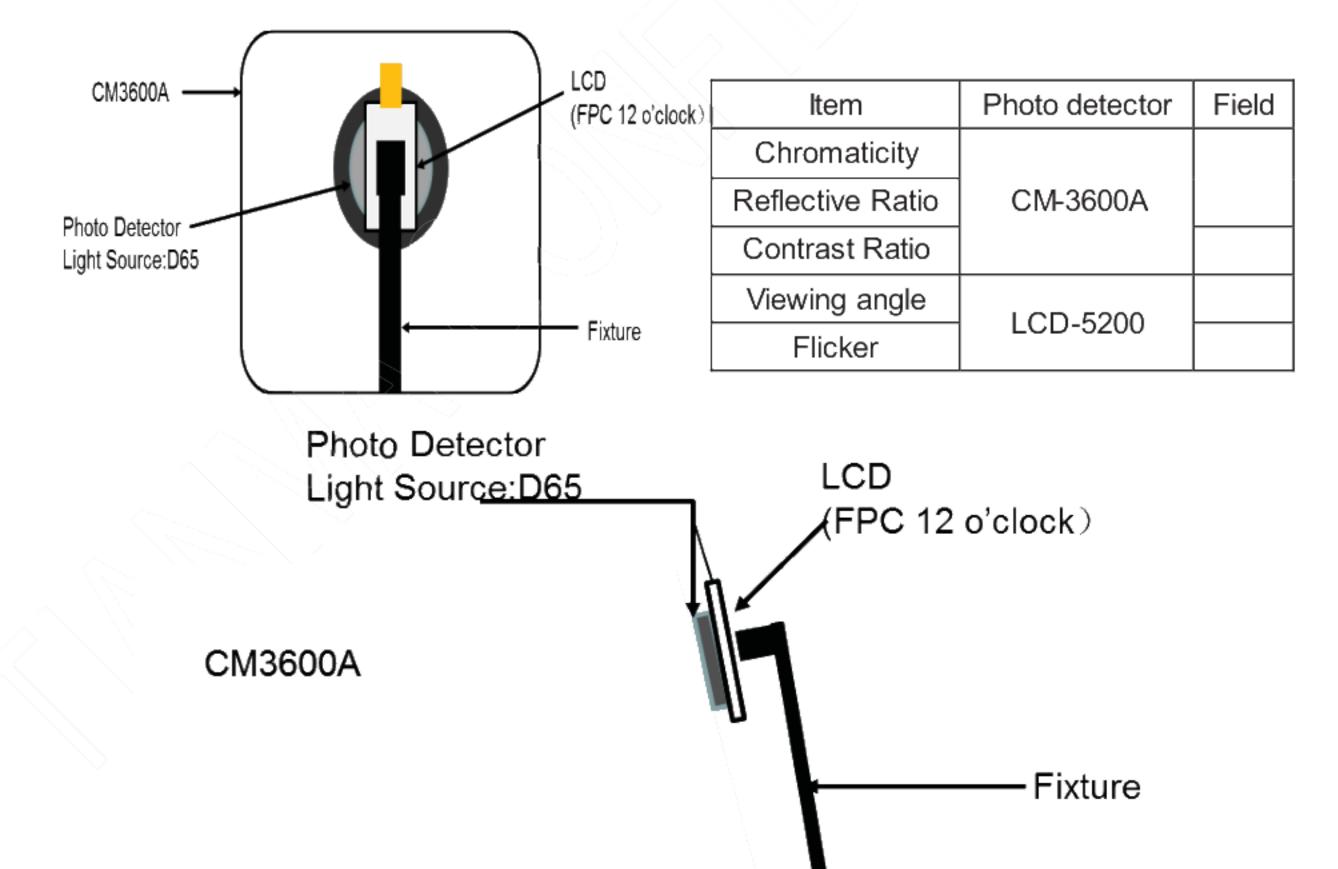
1.Transsitive mode: The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



ltem	Photo detector	Field	
Contrast Ratio			
Luminance	SR-3A	1°	
Chromaticity	SK-SA		
Lum Uniformity			
Response Time	LCD-5200	/	
Flicker	CA-310	/	

The center of the screen

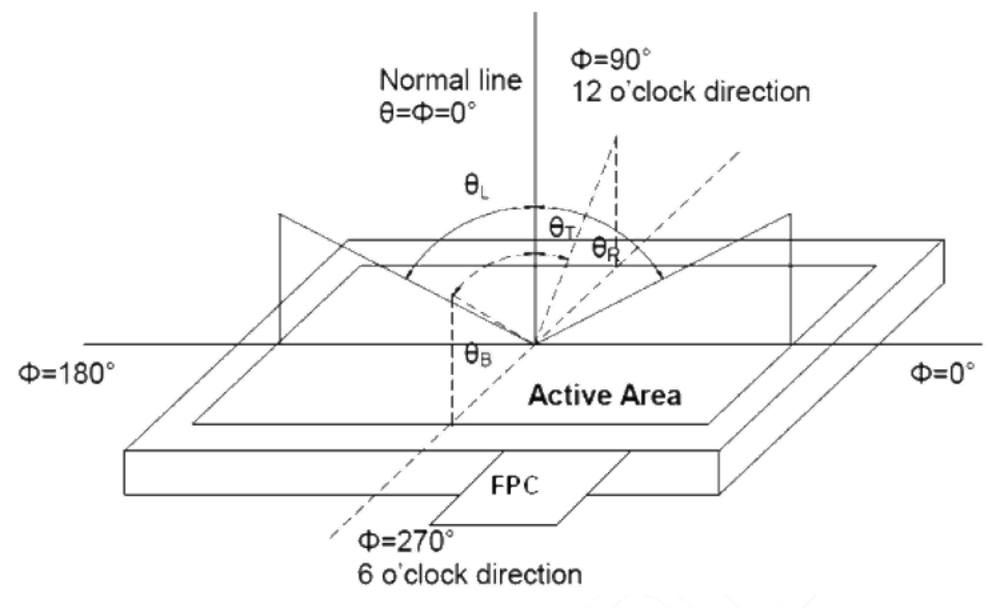
2.Reflective mode





Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



Note 3: Definition of contrast ratio

Contrast ratio (CR) = Luminance measured when LCD is on the "White" state

Luminance measured when LCD is on the "Black" state

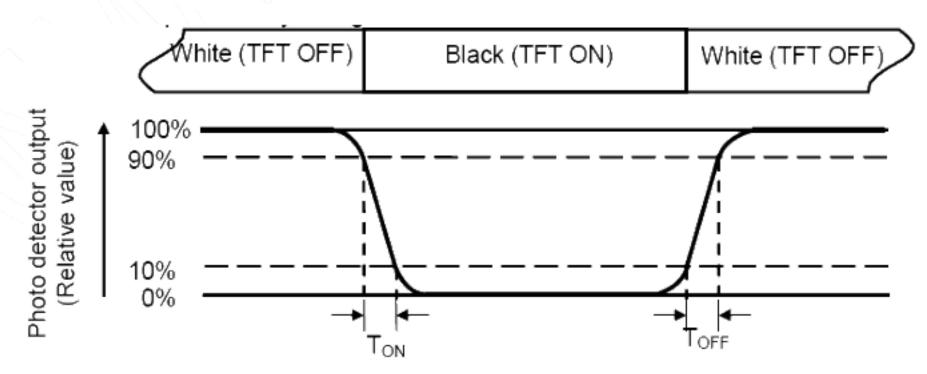
"White state ": The state is that the LCD should drive by Vwhite.

"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

- (1) Color coordinates measured at center point of LCD.
- (2) For reflective mode color chromaticity we need to test at least 3 different batches to make sure the stability of panel and it accepts reasonable change after we get the stability data.

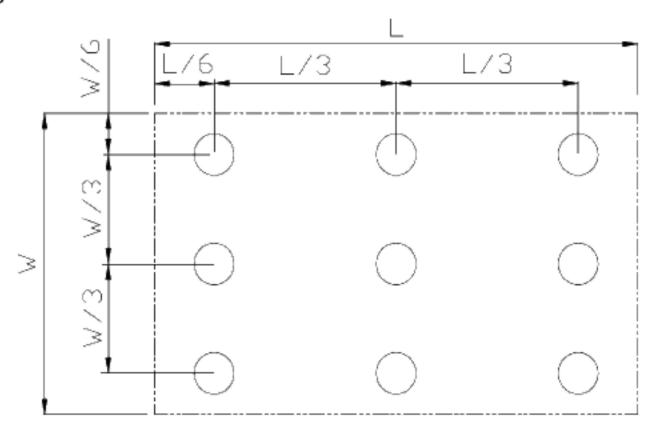


Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax

L-----Active area length W----- Active area width



Lmax: The measured Maximum luminance of all measurement position.

Lmin: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



7. Environmental / Reliability Test

No	Test Item	Condition	Remarks
1	High Temperature Operation	T= +70°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low Temperature Operation	Ta = -20 ℃, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta = +80°C, 240 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta = -30 ℃, 240 hours	IEC60068-2-1:2007 GB2423.1-2008
5	Storage at High Temperature and Humidity	Ta=+60℃, 90% RH 240 hours	IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,GB 2423.22-2002
7	ESD	C=150pF, R=330Ω, 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 °C ~35 °C, 30%~60%, 86Kpa~106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration Test	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6:1982 GB/T2423.10—1995
9	Mechanical Shock (Non OP)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27:1987 GB/T2423.5—1995

Note1: Ts is the temperature of panel's surface.

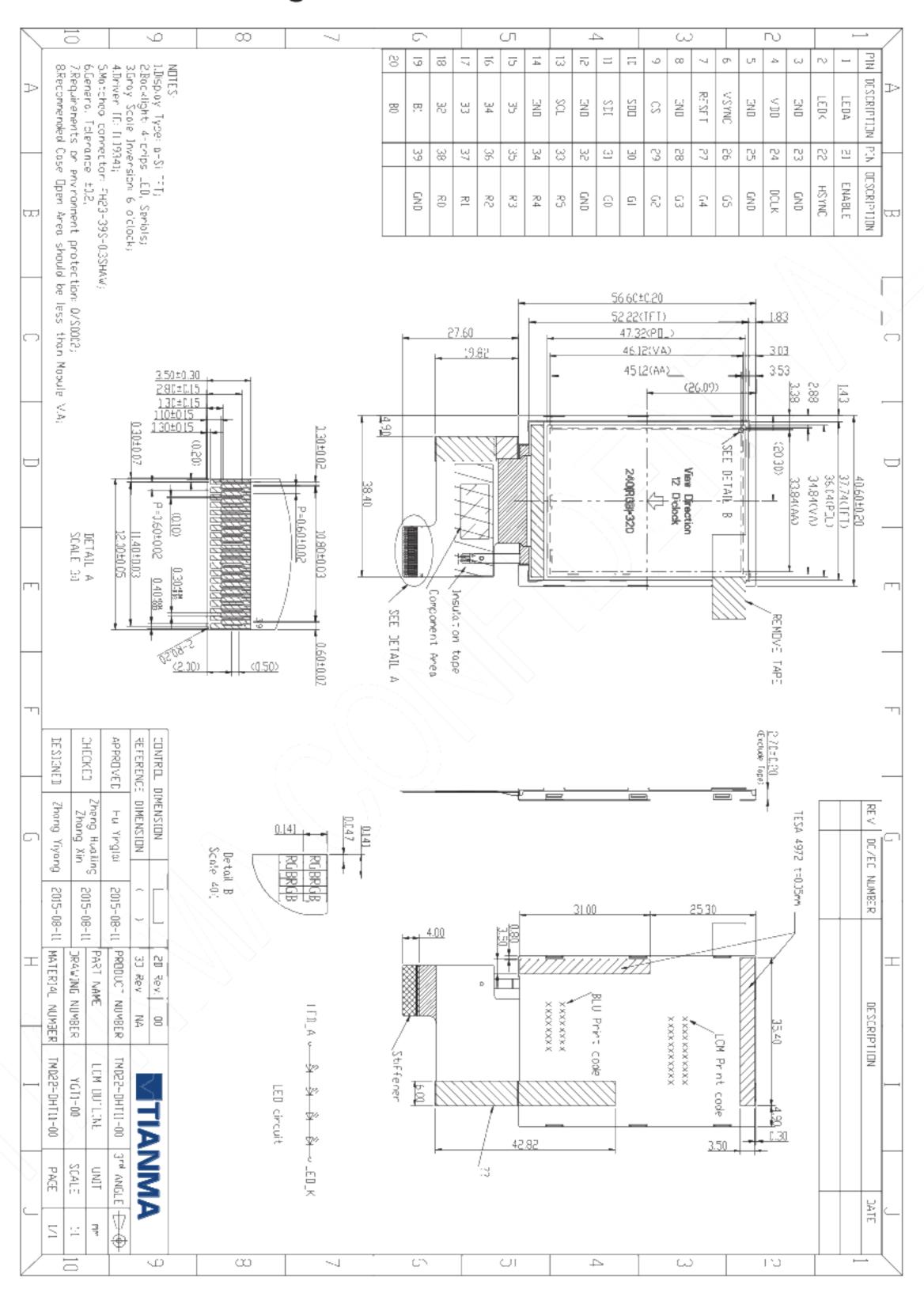
Note2: Ta is the ambient temperature of sample.

Note3: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

Note 4: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.



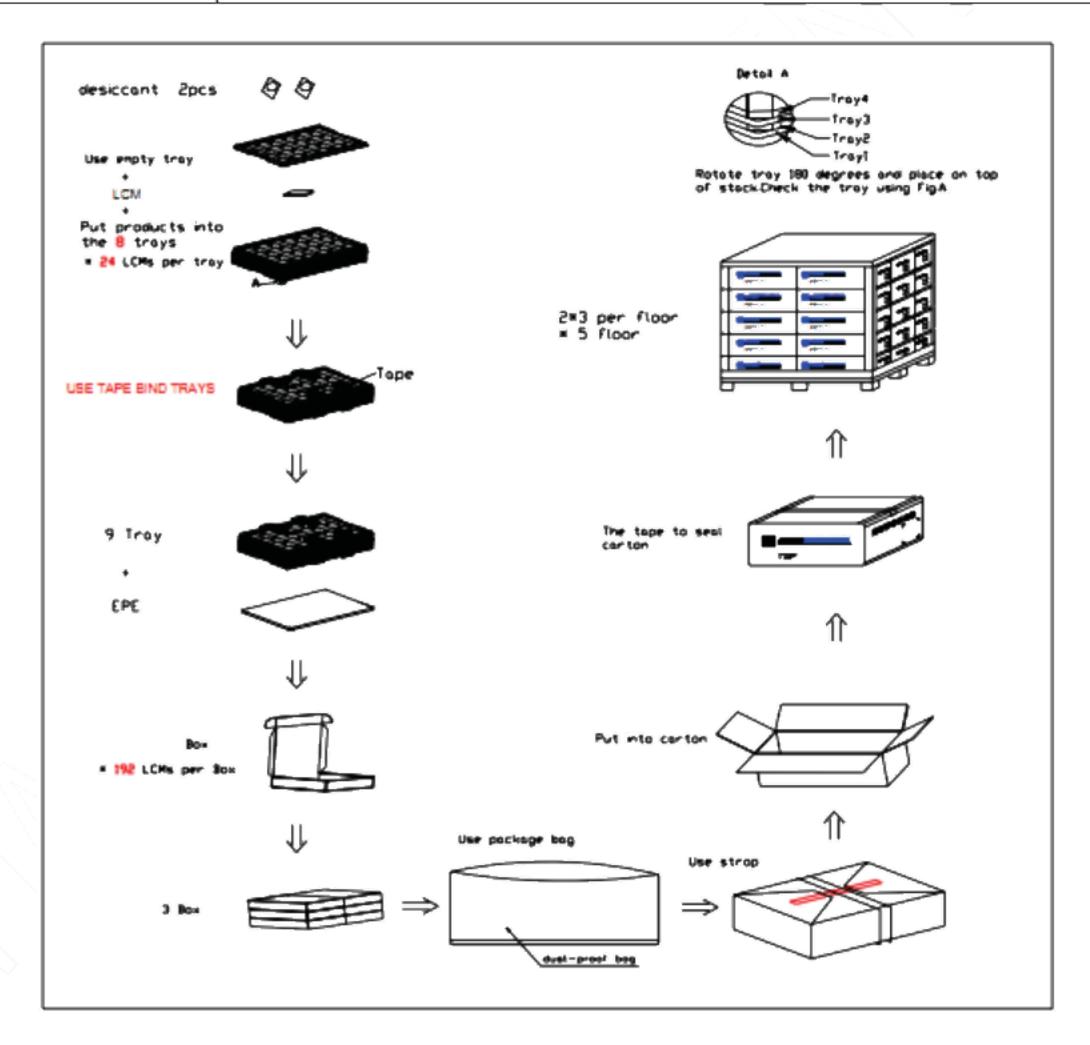
8. Mechanical Drawing





9. Packing Drawing

No	ltem	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM022HDHT11-00	40.6×56.6×2.7	0.01274	576	
2	Tray	PET(Transmit)	485×330×11.3	0.162	27	
3	Anti static BAG	PE	700X545×0.05	0.046	1	
4	BOX	CORRUGATED PAPER	520×345×70mm	0.227	3	
5	Desiccant	DESICCANT	45×35	0.002	6	
6	Carton	CORRUGATED PAPER	544×365×250	1.01	1	
	Total weight		14.38kg			





10. Precautions for Use of LCD Modules

- a) Handling Precautions
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- ii. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- iii. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- iv. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- v. If the display surface is contaMinated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water; Ketone ; Aromatic solvents
- vi. Do not attempt to disassemble the LCD Module.
- vii. If the logic circuit power is off, do not apply the input signals.
- viii. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- b) Storage precautions
 - When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- ii. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

- iii. The LCD modules should be stored in the room without acid, alkali and harmful gas.
- c) Transportation Precautions
 - The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.